

Flip-Chip Package Substrate Market, Global Outlook and Forecast 2022-2028

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Abstracts

This report contains market size and forecasts of Flip-Chip Package Substrate in global, including the following market information:

Global Flip-Chip Package Substrate Market Revenue, 2017-2022, 2023-2028, (\$ millions)

Global Flip-Chip Package Substrate Market Sales, 2017-2022, 2023-2028, (Sqm)

Global top five Flip-Chip Package Substrate companies in 2021 (%)

The global Flip-Chip Package Substrate market was valued at million in 2021 and is projected to reach US\$ million by 2028, at a CAGR of % during the forecast period 2022-2028.

The U.S. Market is Estimated at \$ Million in 2021, While China is Forecast to Reach \$ Million by 2028.

FCBGA Segment to Reach \$ Million by 2028, with a % CAGR in next six years.

The global key manufacturers of Flip-Chip Package Substrate include Unimicron, Ibiden, Nan Ya PCB, Shiko Electric Industries, AT&S, Kinsus Interconnect Technology, Semco, Kyocera and TOPPAN, etc. In 2021, the global top five players have a share approximately % in terms of revenue.

MARKET MONITOR GLOBAL, INC (MMG) has surveyed the Flip-Chip Package Substrate manufacturers, suppliers, distributors and industry experts on this industry,



involving the sales, revenue, demand, price change, product type, recent development and plan, industry trends, drivers, challenges, obstacles, and potential risks.

Total Market by Segment:

Global Flip-Chip Package Substrate Market, by Type, 2017-2022, 2023-2028 (\$ Millions) & (Sqm)

Global Flip-Chip Package Substrate Market Segment Percentages, by Type, 2021 (%)

FCBGA

FCCSP

Global Flip-Chip Package Substrate Market, by Application, 2017-2022, 2023-2028 (\$ Millions) & (Sqm)

Global Flip-Chip Package Substrate Market Segment Percentages, by Application, 2021 (%)

High-end servers

GPU

CPU and MPU

ASIC

FPGA

Global Flip-Chip Package Substrate Market, By Region and Country, 2017-2022, 2023-2028 (\$ Millions) & (Sqm)

Global Flip-Chip Package Substrate Market Segment Percentages, By Region and Country, 2021 (%)



North America			
	US		
	Canada		
	Mexico		
Europe			
	Germany		
	France		
	U.K.		
	Italy		
	Russia		
	Nordic Countries		
	Benelux		
	Rest of Europe		
Asia			
	China		
	Japan		
	South Korea		
	Southeast Asia		
	India		
	Rest of Asia		



South America
Brazil
Argentina
Rest of South America
Middle East & Africa
Turkey
Israel
Saudi Arabia
UAE
Rest of Middle East & Africa
Competitor Analysis
The report also provides analysis of leading market participants including:
Key companies Flip-Chip Package Substrate revenues in global market, 2017-2022 (Estimated), (\$ millions)
Key companies Flip-Chip Package Substrate revenues share in global market, 2021 (%)
Key companies Flip-Chip Package Substrate sales in global market, 2017-2022 (Estimated), (Sqm)
Key companies Flip-Chip Package Substrate sales share in global market, 2021 (%)
Further, the report presents profiles of competitors in the market, key players include:

Unimicron



Ibiden
Nan Ya PCB
Shiko Electric Industries
AT&S
Kinsus Interconnect Technology
Semco
Kyocera
TOPPAN
Zhen Ding Technology
Daeduck Electronics
ASE Material
ACCESS



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